



US00D625252S

(12) **United States Design Patent**
Nguyen et al.

(10) **Patent No.:** **US D625,252 S**
(45) **Date of Patent:** **** Oct. 12, 2010**

(54) **MODULAR POWER SUPPLY**
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(**) Term: **14 Years**

(21) Appl. No.: **29/298,475**

(22) Filed: **Dec. 5, 2007**

(51) **LOC (9) Cl.** **13-02**
(52) **U.S. Cl.** **D13/103; D13/110**
(58) **Field of Classification Search** D13/101–106,
D13/110, 118–119, 123, 162, 184, 199; 429/96–100,
429/163, 176; D9/432; D14/300, 301; 307/150;
361/601, 622; 363/144
See application file for complete search history.

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Primary Examiner—Rosemary K Tarca

(57) **CLAIM**

The ornamental design for a modular power supply, as shown and described.

DESCRIPTION

FIG. 1 is a rear perspective view of the design for the modular power supply;

FIG. 2 is a rear view of the design for the modular power supply as illustrated in FIG. 1;

FIG. 3 is a front view of the design for the modular power supply as illustrated in FIG. 1;

FIG. 4 is a top view of the design for the modular power supply as illustrated in FIG. 1;

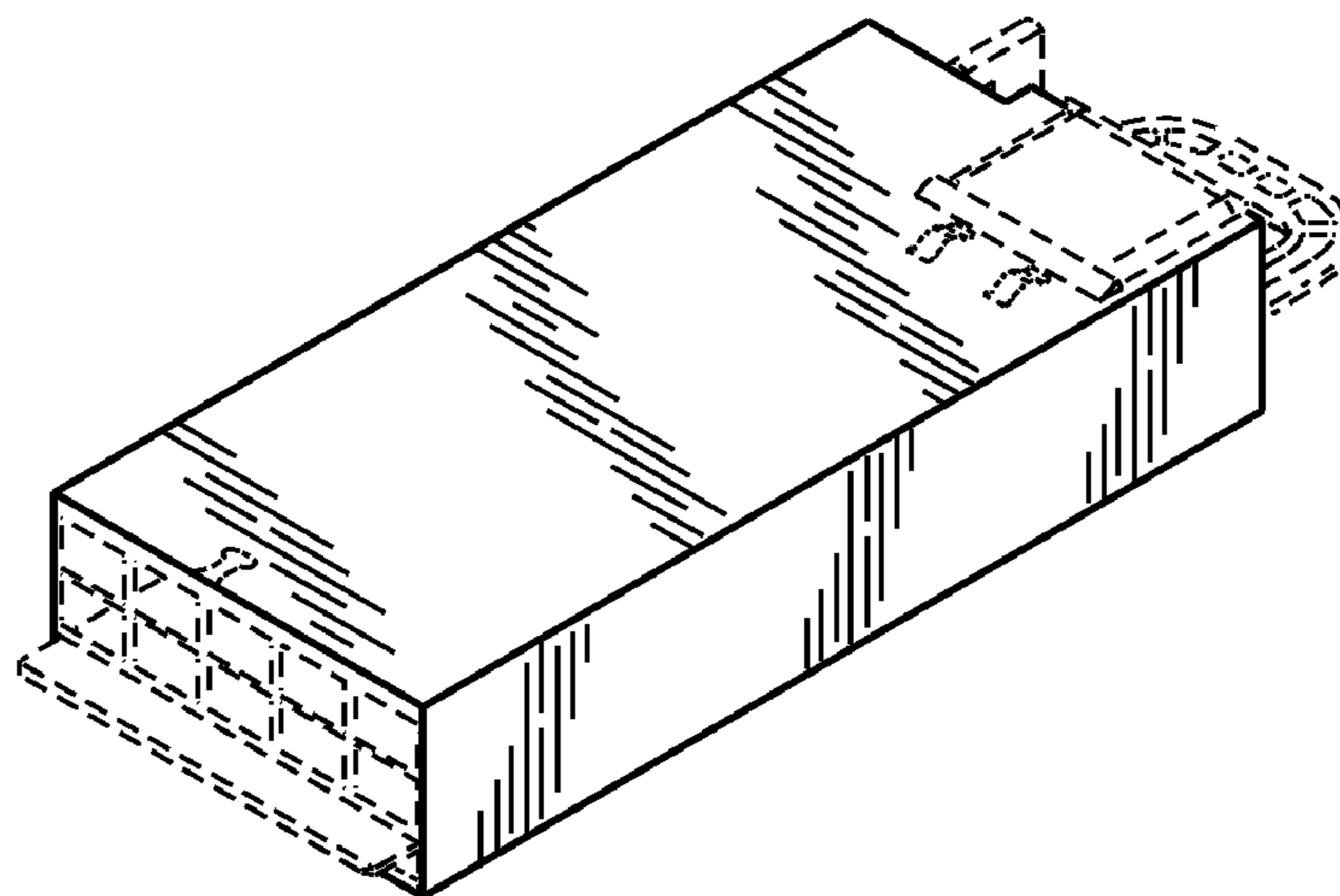
FIG. 5 is a bottom view of the design for the modular power supply as illustrated in FIG. 1;

FIG. 6 is a left view of the design for the modular power supply as illustrated in FIG. 1; and,

FIG. 7 is a right view of the design for the modular power supply as illustrated in FIG. 1.

In these drawings, the solid lines illustrate the claimed ornamental design, whereas the broken lines illustrate environmental features that form no part of the claimed ornamental design.

1 Claim, 4 Drawing Sheets



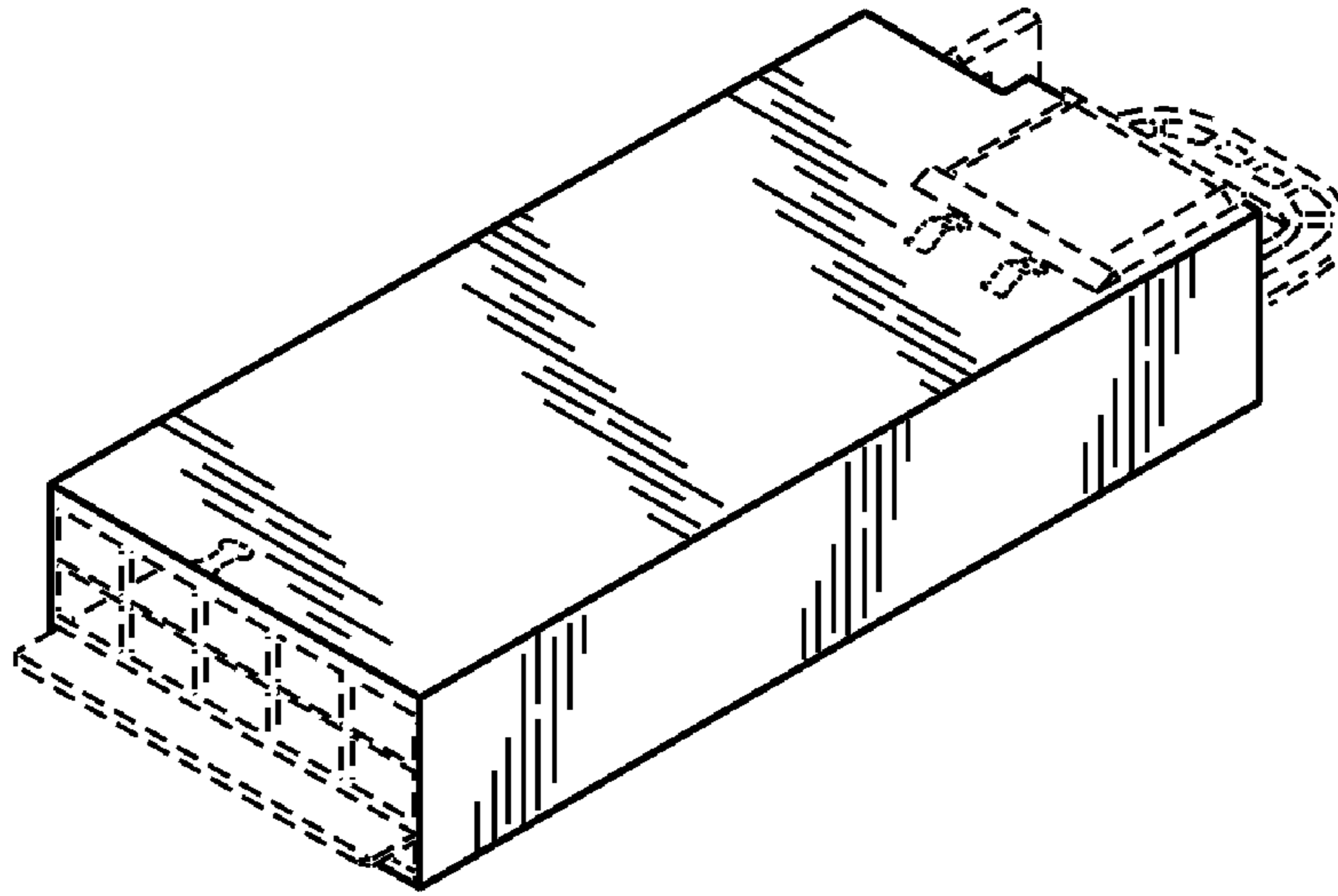


FIG. 1

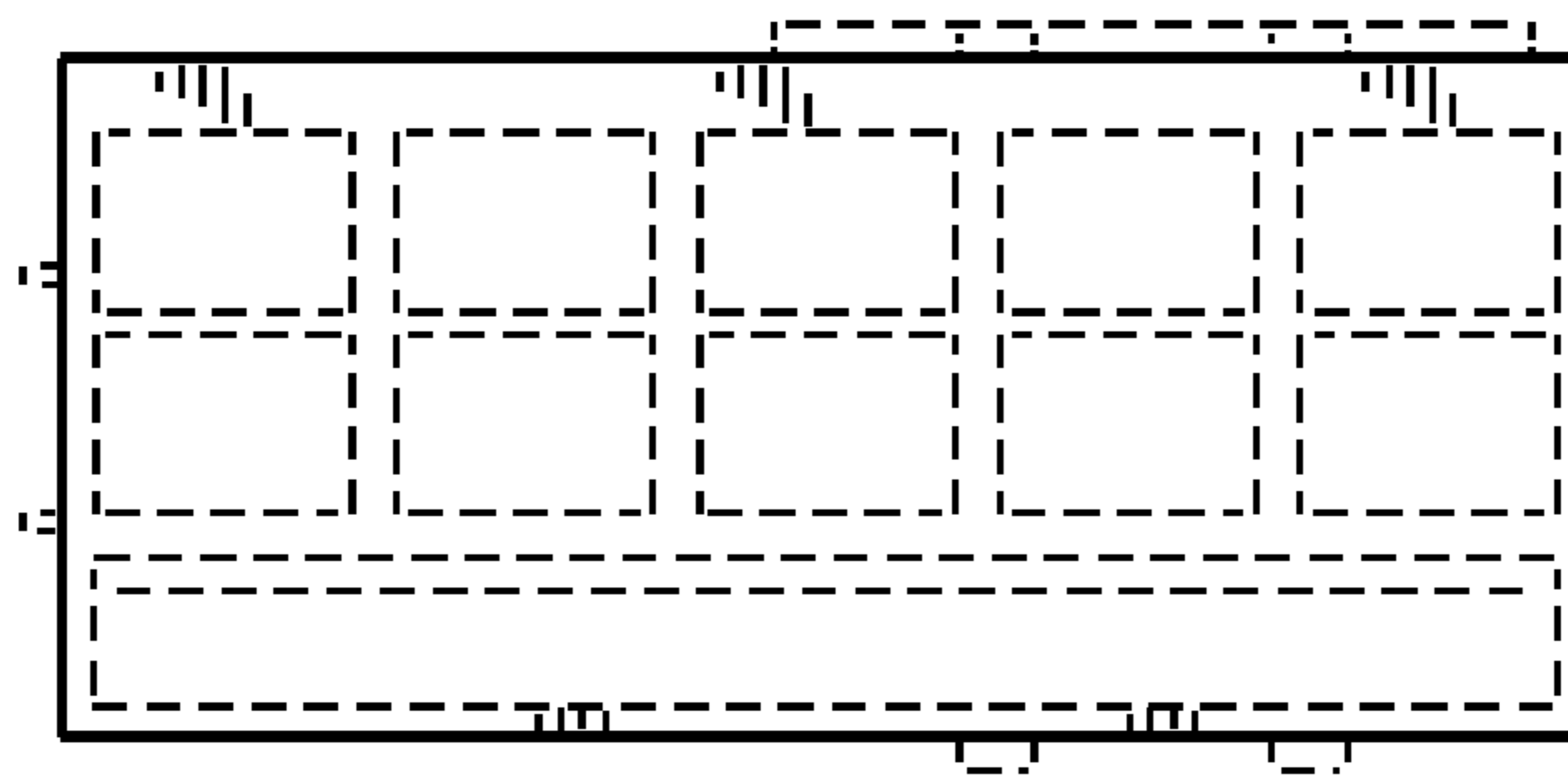


FIG. 2

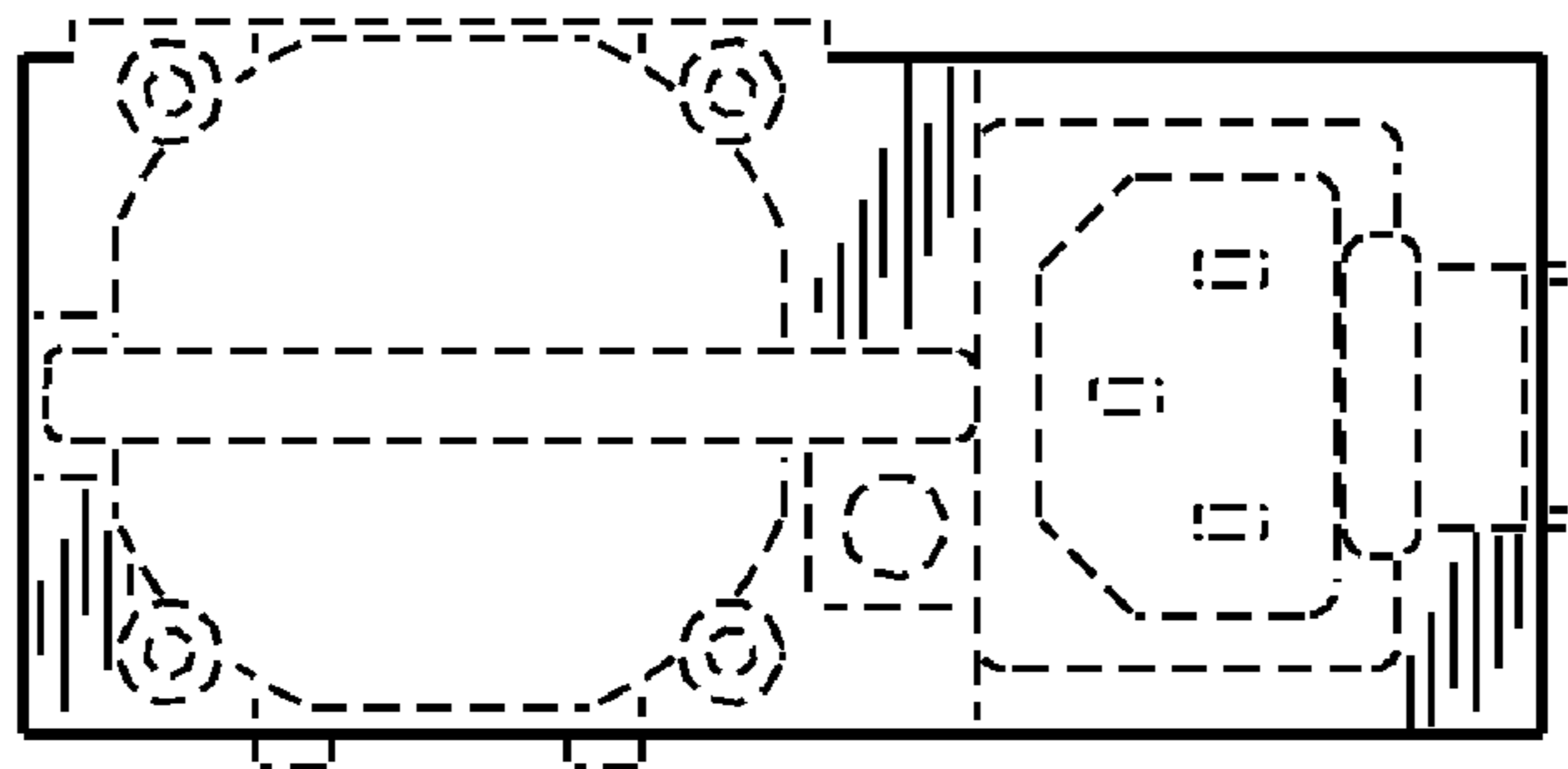


FIG. 3

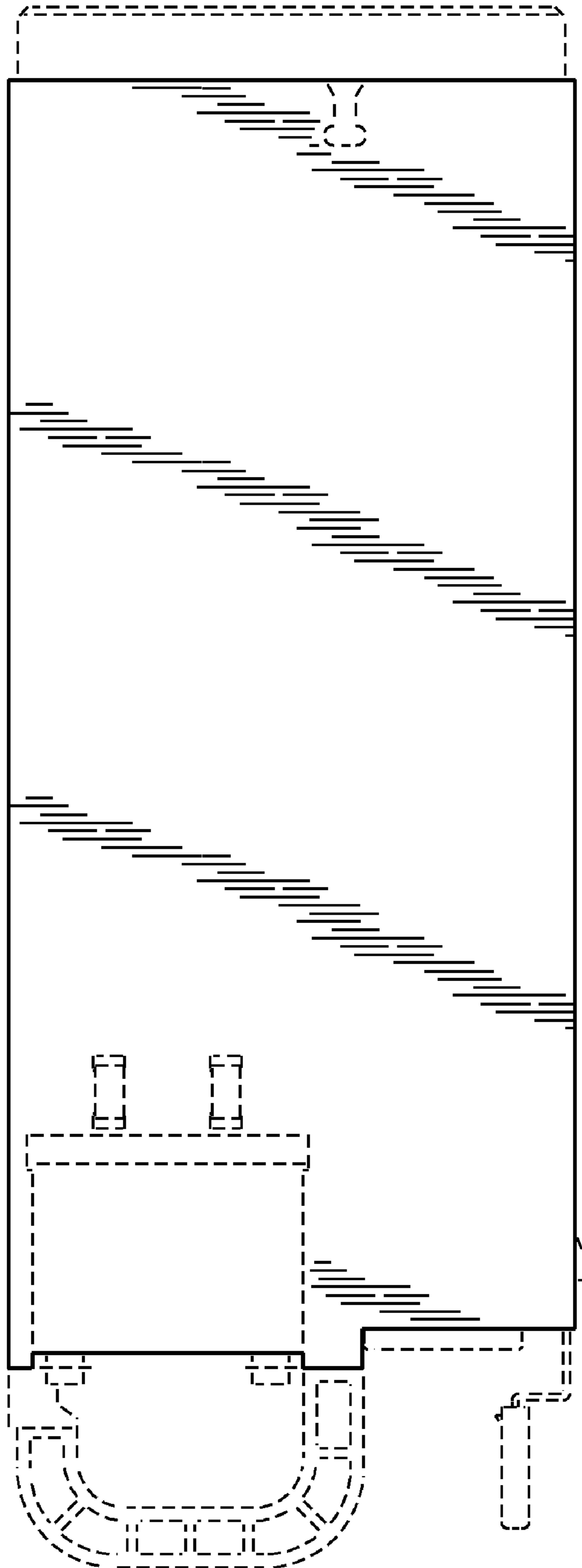


FIG. 4

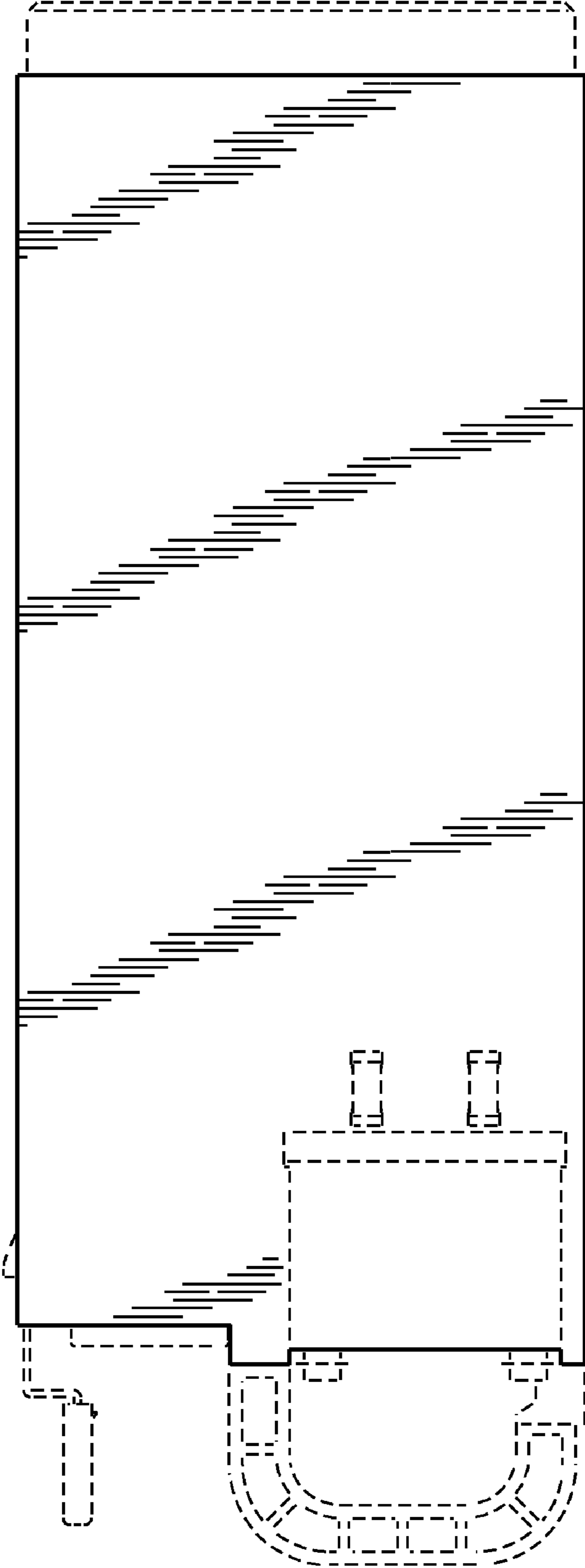


FIG. 5

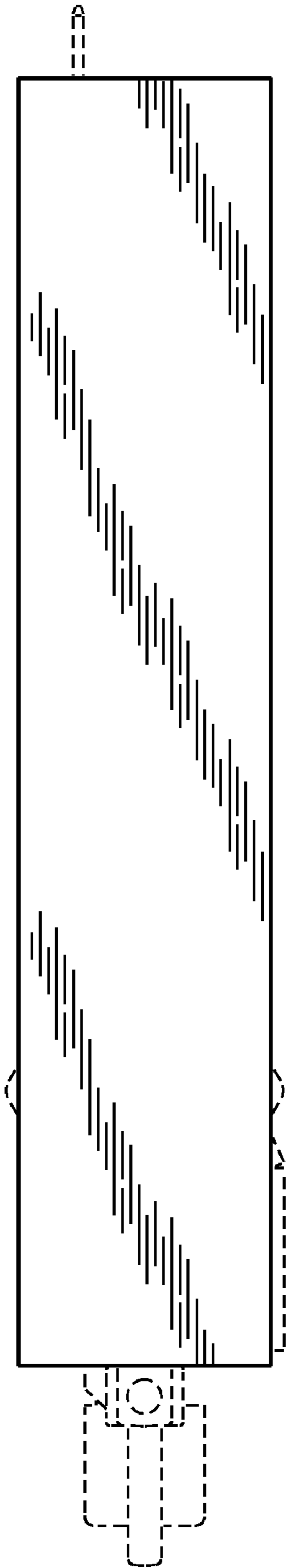


FIG. 6

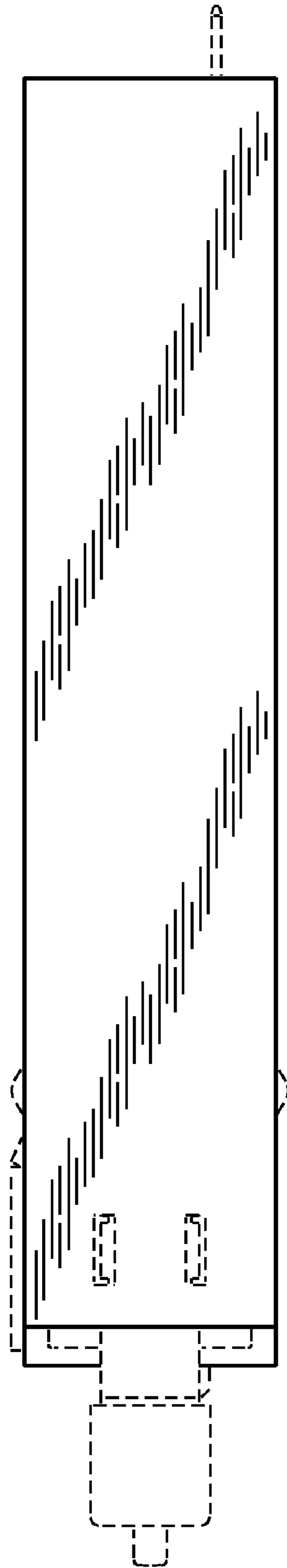


FIG. 7